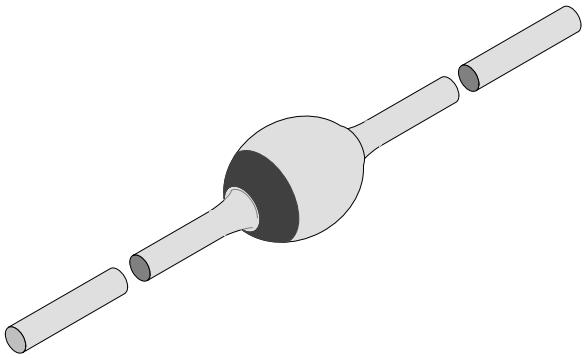
Ultra Fast Silicon Mesa Rectifiers

Features

- Controlled avalanche characteristic
- Low forward voltage
- Ultra fast recovery time
- Glass passivated junction
- Hermetically sealed package



94 9539

Applications

Very fast rectifier e.g. for switch mode power supply

Absolute Maximum Ratings

T_j = 25°C

Parameter	Test Conditions	Type	Symbol	Value	Unit
Peak reverse voltage, non repetitive		BYV27/50	V_{RSM}	55	V
		BYV27/100	V_{RSM}	110	V
		BYV27/150	V_{RSM}	165	V
		BYV27/200	V_{RSM}	220	V
Reverse voltage =Repetitive peak reverse voltage		BYV27/50	$V_R=V_{RRM}$	50	V
		BYV27/100	$V_R=V_{RRM}$	100	V
		BYV27/150	$V_R=V_{RRM}$	150	V
		BYV27/200	$V_R=V_{RRM}$	200	V
Peak forward surge current	t_p=10ms, half sinewave		I_{FSM}	50	A
Repetitive peak forward current			I_{FRM}	15	A
Average forward current			I_{FAV}	2	A
Pulse energy in avalanche mode, non repetitive (inductive load switch off)	$I_{(BR)R}$=0.6A, T_j=175°C		E_R	20	mJ
Junction and storage temperature range			$T_j=T_{stg}$	–65...+175	°C

Maximum Thermal Resistance

T_j = 25°C

Parameter	Test Conditions	Symbol	Value	Unit
Junction ambient	l=10mm, T_L=constant	R_{thJA}	45	K/W
	on PC board with spacing 25mm	R_{thJA}	100	K/W

Electrical Characteristics

T_j = 25°C

Parameter	Test Conditions	Type	Symbol	Min	Typ	Max	Unit
Forward voltage	I_F=3A		V_F			1.07	V
	I_F=3A, T_j=175°C		V_F			0.88	V
Reverse current	V_R=V_{RRM}		I_R			1	µA
	V_{RSM}		I_R			100	µA
	V_R=V_{RRM}, T_j=165°C		I_R			150	µA
Reverse recovery time	I_F=0.5A, I_R=1A, i_R=0.25A		t_{rr}			25	ns

Characteristics (T_j = 25°C unless otherwise specified)

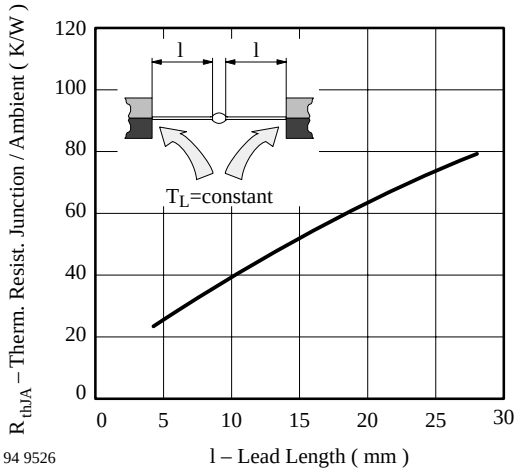


Figure 1. Typ. Thermal Resistance vs. Lead Length

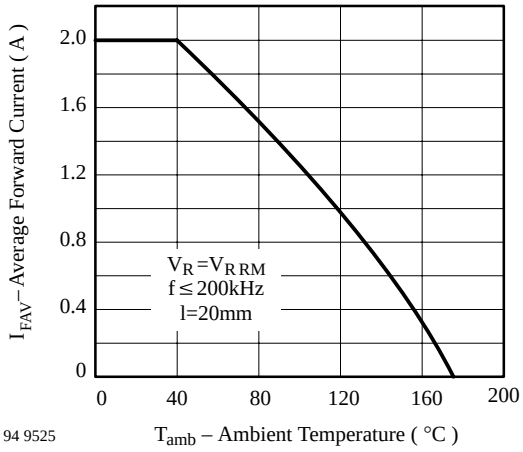


Figure 3. Max. Average Forward Current vs. Ambient Temperature

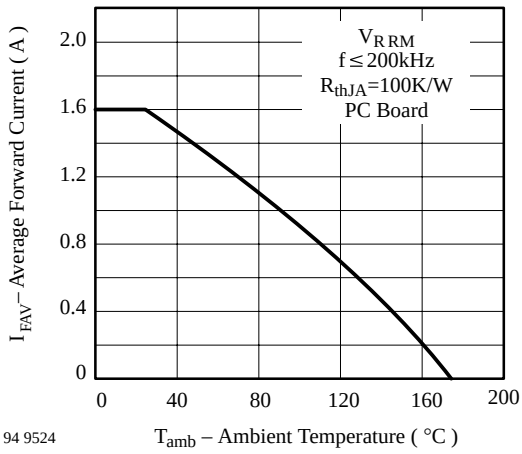


Figure 2. Max. Average Forward Current vs. Ambient Temperature

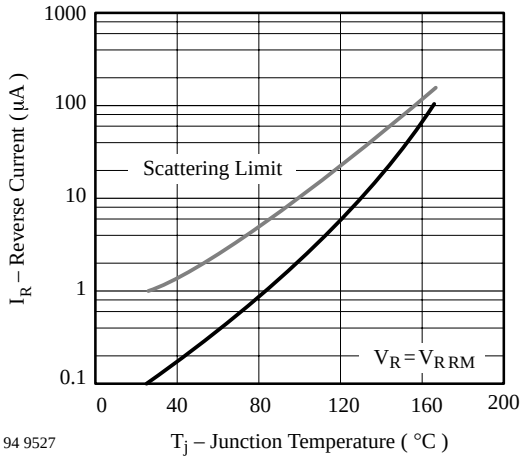


Figure 4. Reverse Current vs. Junction Temperature

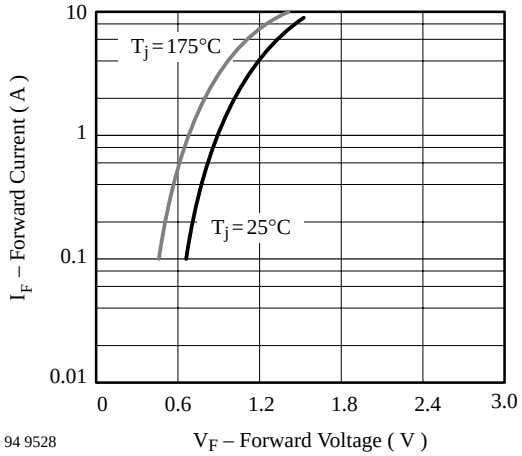
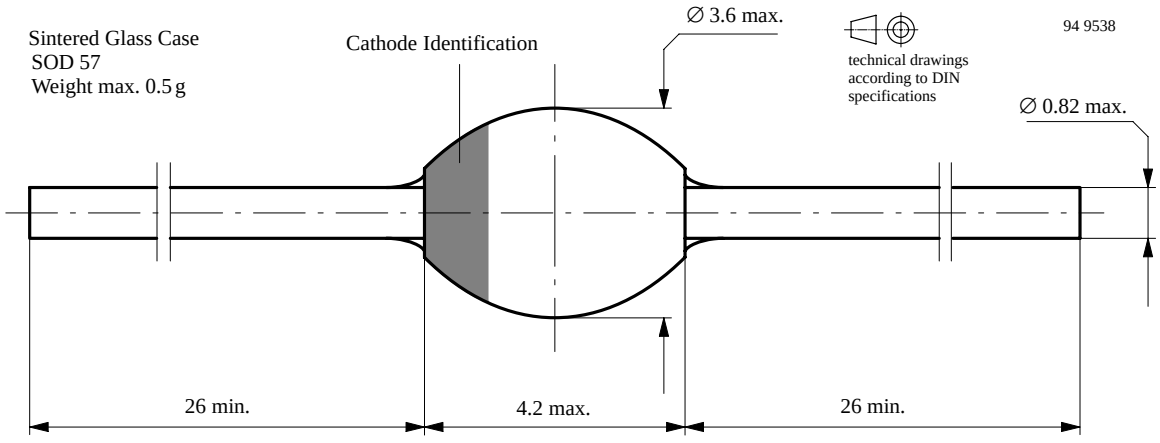


Figure 5. Max. Forward Current vs. Forward Voltage

Dimensions in mm



Ozone Depleting Substances Policy Statement

It is the policy of **Vishay Semiconductor GmbH** to

1. Meet all present and future national and international statutory requirements.

2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems
   with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively

2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA

3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice.
Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay-Telefunken products for any unintended or unauthorized application, the buyer shall indemnify Vishay-Telefunken against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

Vishay Semiconductor GmbH, P.O.B. 3535, D-74025 Heilbronn, Germany
Telephone: 49 (0)7131 67 2831, Fax number: 49 (0)7131 67 2423